										
FORM PTO 14	49 (modified)	ATTY DOCKET NO 03500.010530.4 (35.C10530 C1/D2) APPLICATION NO 09/161,774								
			APPLICANT Kiyofumi SAKAGUCHI, et al.							
LIST	OF REFERENCES CITED BY APPLIC (Use several sheets if necessary)	ANT(S)			<u>í</u> -					
Dated Submitt	ed to USPTO: August 25, 2006	September 29,	1998		2823					
		U	J.S. PATENT DOCUMENTS		····	·				
*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLAS	S FILING DATE IF APPROPRIATE				
GF	6,194,245	02/27/2001	Tayanaka	438	57					
GF	6,326,280	12/04/2001	Tayanaka	438	409					
GF	6,426,274	07/30/2002	Tayanaka	438	458					
GF	2003/0087503 A1	05/08/2003	Sakaguchi, et al.	438	406					
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GF	5-218464	08/27/1993	Japan			Yes & Abstract				
GF	5-299362	11/12/1993	Japan			Yes & Abstract				
GF	4-034961	02/05/1992	Japan			Yes & Abstract				
GF	5-021338	01/29/1993	Japan	/	/	Abstract				
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Submitted: November 2			FILING DATE September 29	, 1998	GROUP	2823			
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(É	4,116,751	09/26/78	Zaromb	156	600				
	4,727,047	02/23/88	Bozler, et al.	437	89				
	5,248,621	09/28/93	Sano	437	3				
	5,250,460	10/05/93	Yamagata, et al.	437	62				
	5,277,748	01/11/94	Sakaguchi, et al.	156	630				
	5,278,092	01/11/94	Sato	437	90	· · · · · · · · · · · · · · · · · · ·			
	5,278,093	01/11/94	Yonehara	437	109				
	5,285,078	02/08/94	Mimura, et al.	257	3				
	5,290,712	03/01/94	Sato, et al.	437	24	<u> </u>			
	5,320,907	06/14/94	Sato	428	446				
	5,331,180	07/19/94	Yamada, et al.	257	3				
	5,362,683	11/08/94	Takenaka, et al.	437	226				
	5,363,793	11/15/94	Sato	117	2				
	5,371,037	12/06/94	Yonehara	437	86				
	5,374,564	12/20/94	Bruel	437	24				
	5,403,771	04/04/95	Nishida, et al.	437	89				
	5,433,168	07/18/95	Yonehara	117	90				
	5,453,394	09/26/95	Yonehara, et al.	437	62				
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()	5,536,361	07/16/96	Kondo, et al.	156	630.1				
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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT(S)				APPLICANT KIYOFUMI SAKAGUCHI, ET AL.					
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MM 2 5	(8)	5,670,411	09/23/97	Yonehara, et al.	437	62			
20.		5,811,348	09/22/98	Matsushita, et al.	438	455			
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		5,863,830	01/26/99	Bruel, et al.	438	478			
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EXAMINER		Fourson		DATE CONSIDERED	5/21/06				

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	us	PATEN	IT AND TRADEMARK OFFICE ERENCES CITED BY APPLICAN	т(S)	APPLICANT KIYOFUMI SAKAGUCHI, ET AL.				
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	1	JP	60-196955 ∨	10/05/85	Japan		· · · · · · · · · · · · · · · · · · ·		Abstract
		JР	62-108539 V	05/19/87	Japan				Abstract
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		JP	03-70156	03/26/91	Japan				Abstract
		JР	05-211128	08/20/93	Japan		÷1		Abstract
<u> </u>		JP	05-283722	10/29/93	Japan				Translation
		JP	06-45622	02/18/94	Japan				Translation
		JP	07-79016	03/20/95	Japan				Abstract
		JP	07-211602	08/11/95	Japan				Abstract
	\bot	JP	07-302889	11/14/95	Japan				Abstract
	<u>(</u> }	JP	07-326719	12/12/95	Japan		=1=-1		Abstract
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FORM PTO 144	9 (modified)	ATTY DOCKET NO 03500.0 10530.4 (35.C10530 C1/D2) APPLICATION NO 09/161,774				NO 19/161,774				
	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	APPLICANT Kiyofumi SAKAGUCHI, et al.								
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GF	4,670,763	06/02/1987		Ovshinsky, et al.	357	4				
GF	4,555,586	11/26/1985		Guha, et al.	136	25	9			
GF	4,426,657	01/17/1984		Abiru, et al.	357	29				
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Sheet <u>1</u> of <u>2</u>

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EXAMINER	7	George Fourson/		DATE CONSIDERED 09/11/	2006			

Sheet 2 of 2

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